

GL1F20/GL1F201 IrDA1.0 Compliant Infrared Emitting Diode

■ Features

1. Compliant with IrDA1.0
(Date rate : 2.4k to 115.2kbps)
2. Built-in infrared emitting diode circuit
3. Pair use with **IS1U20** is recommended.

■ Applications

1. Personal computers
2. Personal information tools (PDA)
3. Printers
4. Word processors

IrDA : Abbreviation of the Infrared Data Association established for standardization of infrared communication specifications

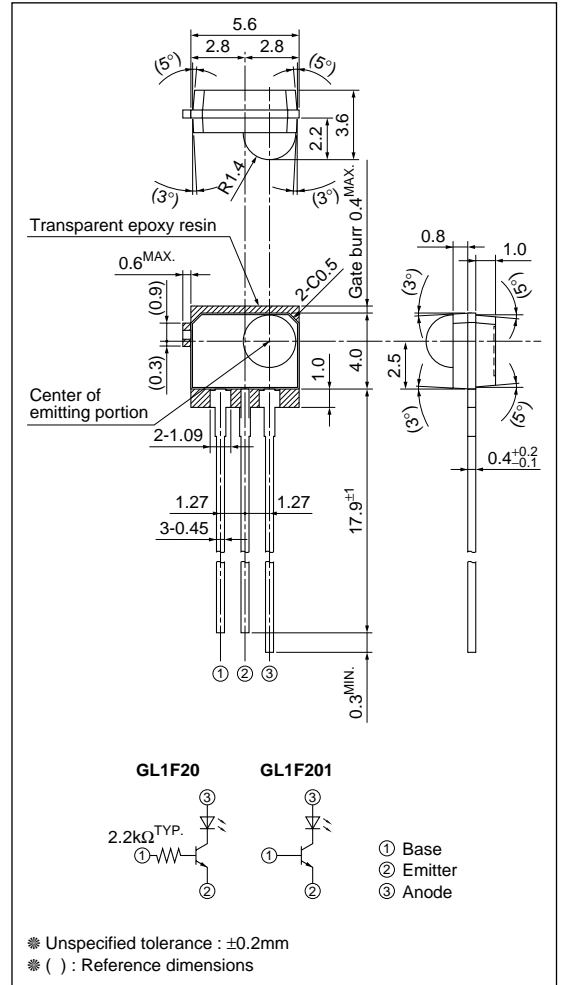
■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Forward current	I_F	50	mA
*1 Peak forward current	I_{FM}	400	mA
Operating temperature	T_{opr}	-10 to +70	°C
Storage temperature	T_{stg}	-20 to +85	°C
*2 Soldering temperature	T_{sol}	260	°C

*1 Pulse width 78.1 μ s, Duty ratio=3/16

*2 For MAX. 3s at the position of 2 mm from the resin edge

■ Outline Dimensions (Unit : mm)



■ Electro-optical Characteristics

(Ta=25°C)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit	
		GL1F20	GL1F201					
Operating voltage	GL1F20	V _{CC}	-		4.75	-	5.25	V
	GL1F201				2.7		3.3	
High level input voltage	GL1F20	V _{IH}	V _{CC} =4.75 to 5.25V	V _{CC} =2.7 to 3.3V	4.5	-	V _{CC}	V
	GL1F201				2.4			
Low level input voltage	V _{IL}	V _{CC} =4.75 to 5.25V	V _{CC} =2.7 to 3.3V	-	-	0.4	V	
Peak emission wavelength	λ_p	I _F =20mA		850	870	900	nm	
Radiant intensity	I _E			40	-	350	mW/sr	
Pulse width	GL1F20	tw	V _{CC} =5V, R _L =7.5Ω * ³ V _{IN} =4.5V	V _{CC} =3V, R _L =2.2Ω * ³ V _{IN} =2.7V, R _B =1kΩ±5% C _B =1500pF, t _{WIN} =1.63μs DR=3/16, * ⁴ φ<=15°	1.41	1.6	2.71	μs
	GL1F201					1.7		
Rise time	GL1F20	t _r	t _{WIN} =1.63μs, DR=3/16 φ<=15°, * ⁴	C _B =1500pF, t _{WIN} =1.63μs DR=3/16, * ⁴ φ<=15°	-	0.23	0.6	μs
	GL1F201					0.09		
Fall time	GL1F20	t _r	φ<=15°, * ⁴	DR=3/16, * ⁴ φ<=15°	-	0.17	0.6	μs
	GL1F201					0.21		
Input current	GL1F20	I _{IH}	* ³ V _{IN} =4.5V	* ³ V _{IN} =2.4V	1.0	-	3.0	mA
	GL1F201				1.2		2.3	
Spectrum radiation bandwidth	$\Delta \lambda$	I _F =20mA		-	40	-	nm	
Half intensity angle	$\Delta \theta$	I _F =20mA		-	±20	-	°	

*³ Refer to the recommended circuit.*⁴ Direction of mechanical axis of the lens portion of the element : φ=0°

Fig.1 Peak Forward Current vs. Ambient Temperature

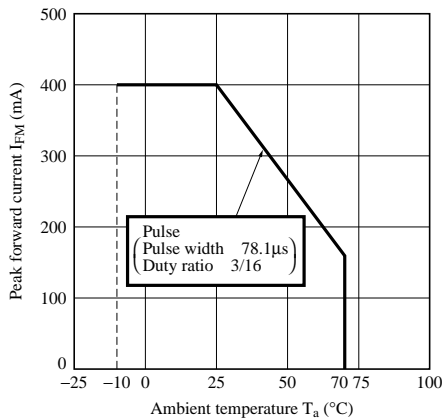


Fig.2 Spectral Distribution

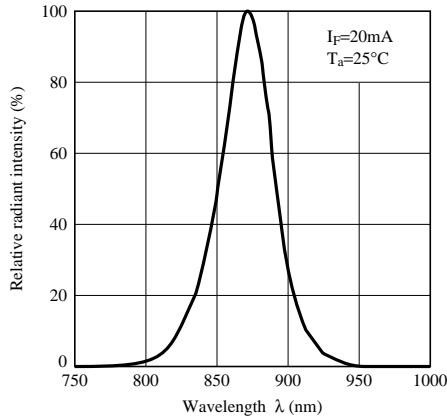


Fig.3 Peak Emission Wavelength vs. Ambient Temperature

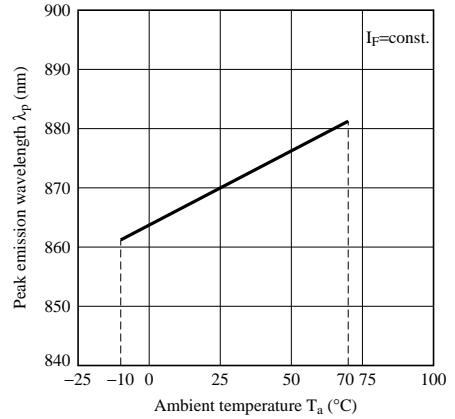


Fig.4 Relative Radiant Intensity vs. Ambient Temperature

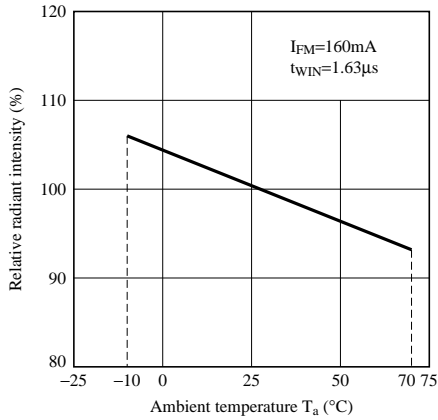


Fig.5 Radiant Intensity vs. Peak Forward Current

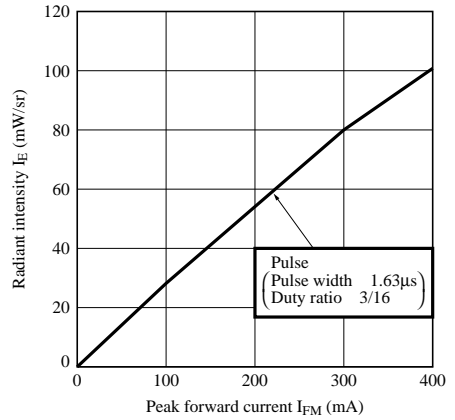


Fig.6 Radiation Diagram

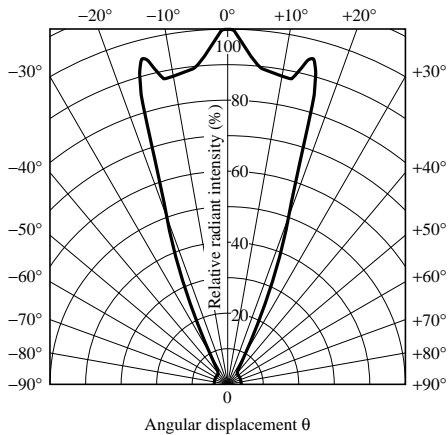


Fig.7 Recommended Circuit(GL1F20)

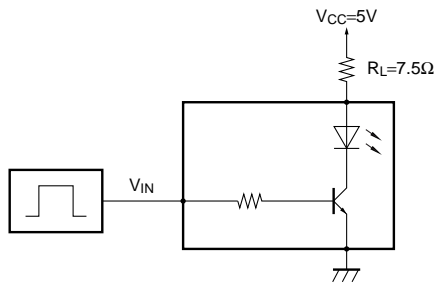


Fig.8 Recommended Circuit(GL1F201)

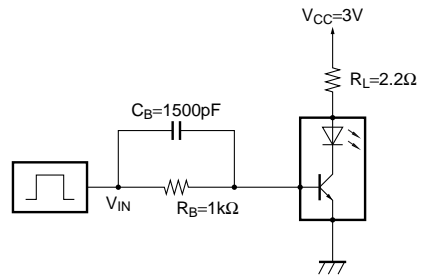
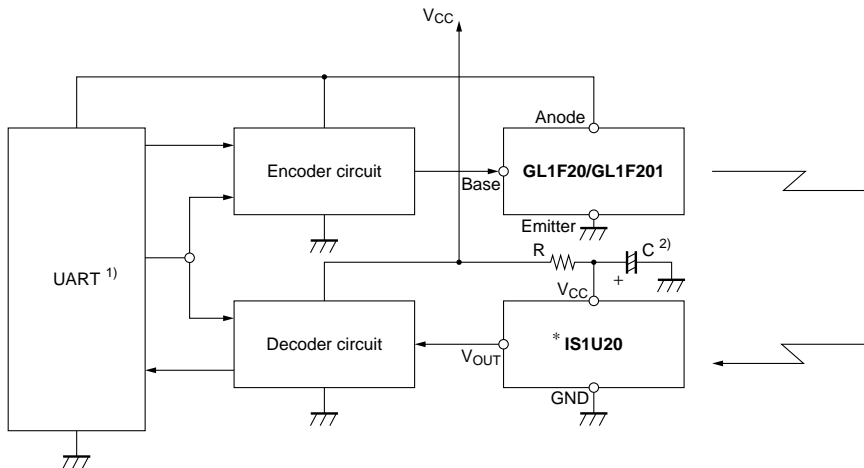


Fig.9 Example of Infrared Data Communication System



- 1) UART (Universal Asynchronous Receiver/Transmitter)
- 2) Please choose the most suitable C and R according to the noise level and noise frequency of power supply.
Example : C=47μF, R=47Ω

* We recommended to use IS1U20 as detecting device.

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 - Alarm equipment
 - Various safety devices, etc.
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